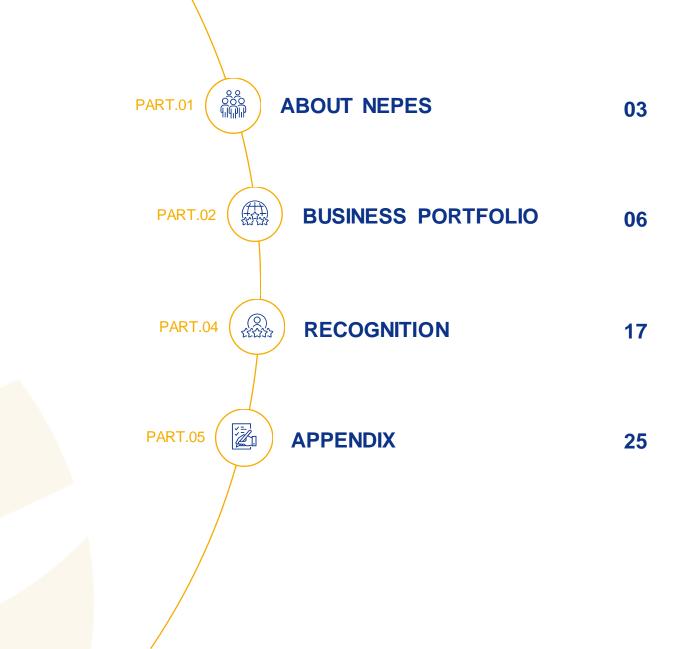
# ne es 2023 INTRODUCTION

Semiconductor | Chemicals | Energy



neres



Part.01

# ABOUT NEPES

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BUSINESS PORFOLIO	05

BUSINESS PORFOLIO

ne¦ses

RECOGNITION





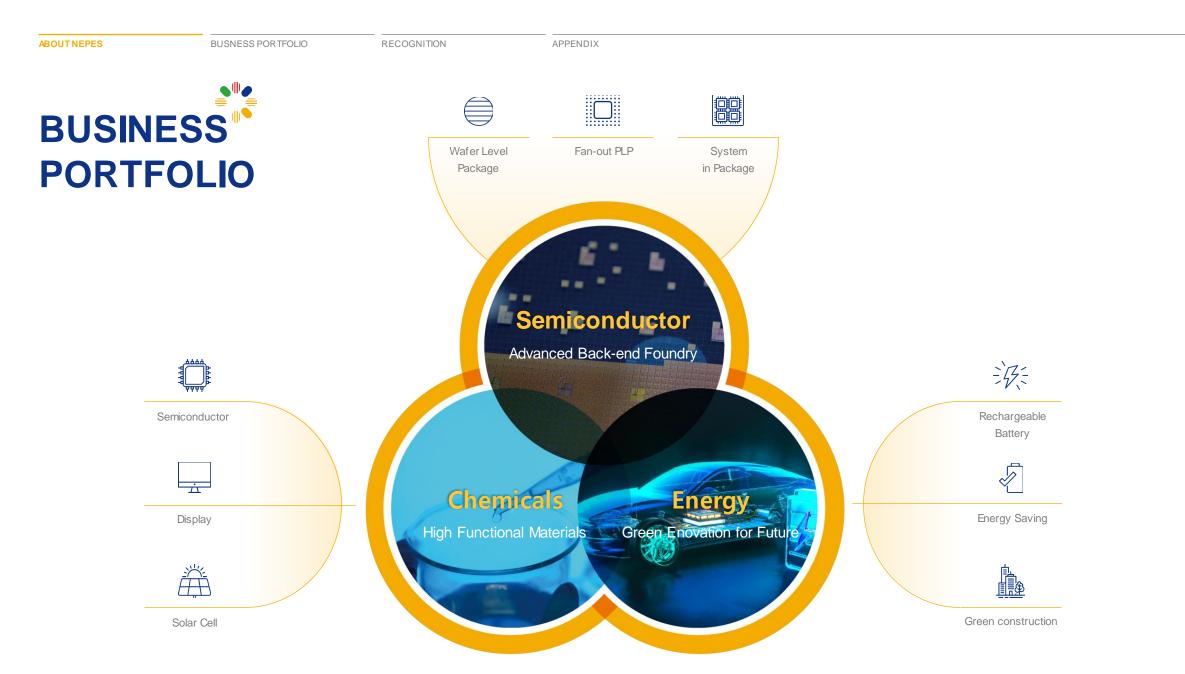
'nepes' means 'Eternal Life' in Hebrew.

## The name of 'nepes' contains the vision of vitality and sustainability.

Name of company	nepes
Date of establishment	1990.12
CEO	Byung-Koo Lee
Competitiveness	Leading technology, top quality, corporate culture
Location	<ul> <li>Korea: 7 regions (Chungcheongbuk-do, Seoul)</li> <li>International: 5 regions (CN, US, PHL, IDN)</li> </ul>
Listed	nepes(1999.12) / nepesArk(2020.11)
# of employee	2,840(2023.01)

Global top-tier partner, nepes 4

ne¦;es



Part.02

# BUSINESS PORTFOLIO

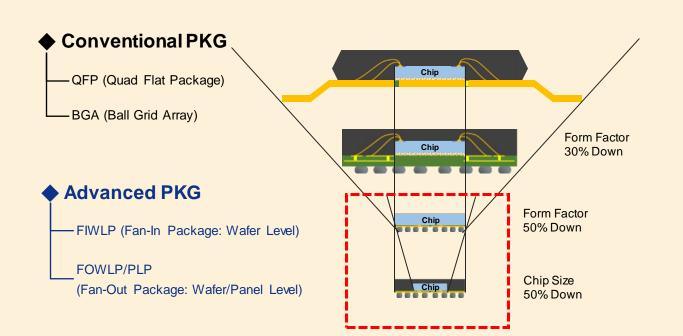
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CORE TECHNOLOGY

## **01.SEMICONDUCTOR**

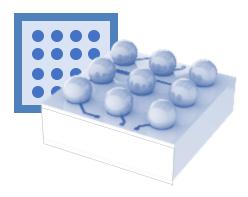
Nepes provides core back-end solutions for advanced semiconductor packaging





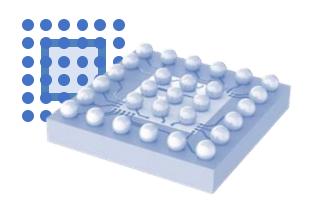
Developed and mass-produced WLP technology for the first time in Korea / Developed and mass-produced PLP for the first time in the world / Mass-produced ultra-thin SiP(nePAC)

RECOGNITION



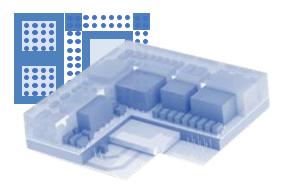
## WLP Solutions

- Wafer Level Packaging chip size packaging solution
- 8 & 12inches turnkey service
- 300mm FOWLP (KR, PH)



## **FOPLP Solutions**

- Fan Out packaging @ 600mm sq. PLP
- World 1<sup>st</sup> 600 mm PLP production
- Single & multi dies packaging
- Package on Package



## nePAC Solutions

- Nepes System in Packaging
- No substrate -Chip last on RDL interposer
- High integration & small form factor

RECOGNITION

# SEMICONDUCTOR

Advanced Back-end Foundry Solutions | Ecosystem Transformation

Nepes is growing together with global top-tier customers.

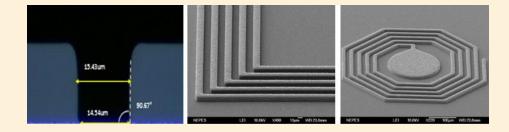
## New ecosystem



CORE TECHNOLOGY

## 02.CHEMICALS

Nepes supplies core materials for advanced semiconductors and displays



Nega PR : NNBP-103T, NUTP-264

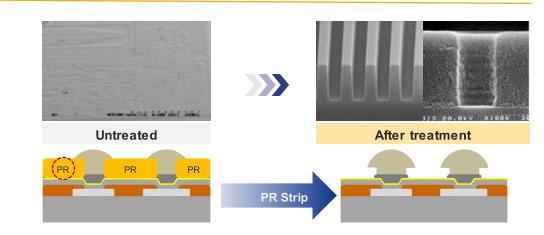


Nepes provides cutting-edge polymerized lithography materials and functional wet chemicals that are applied to the manufacturing processes of semiconductor and display devices

RECOGNITION

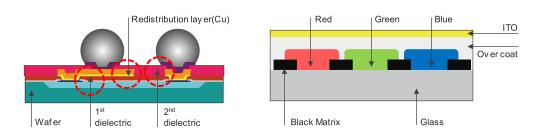
#### Process chemicals

- PR
- Developer
- Stripper
- Etchant



### **Functional chemicals**

- ILD/PSPI
- Cu Plating
- Color paste



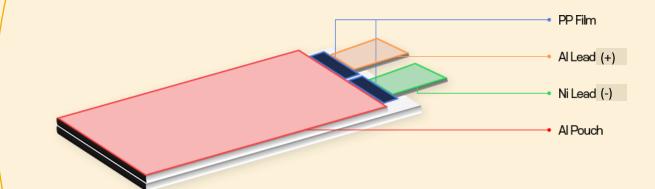
#### **Applications**



CORE TECHNOLOGY

# 03.Energy

Nepes provides sustainable and eco-friendly energy solutions.



ABOUTNEPES

Polym

RECOGNITION

LitthiumIon

APPENDIX

# ENERGY | Lead Tab

Nepes is enlarging its position in the market by mass production of the lead tab, which is a part of the rechargeable battery.

Thermal barrie assembly

### Lead Tab

### **Service & Products**

- Lead Tab
- Thermal barrier assembly
- LIB anode electrode

### Applications



RECOGNITION APPENDIX

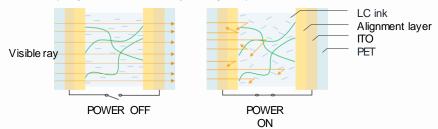
Signage application case

## ENERGY | Smart film

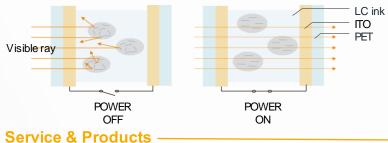
Nepes successfully commercialized the world's first reverse smart film(PNLC) by applying its expertise in electronic materials technology. Additionally, Nepes smart film can be easily applied to buildings or automobiles, providing a convenient electronic blind function with excellent optical properties and high energy-saving.

#### Super LC Structure and Principles -

• PNLC (Polymer Network Liquid Crystal)



• PDLC (Polymer Dispersed Liquid Crystal)



- Service & Produ
- Building & Interior

Super LC(PNLC)

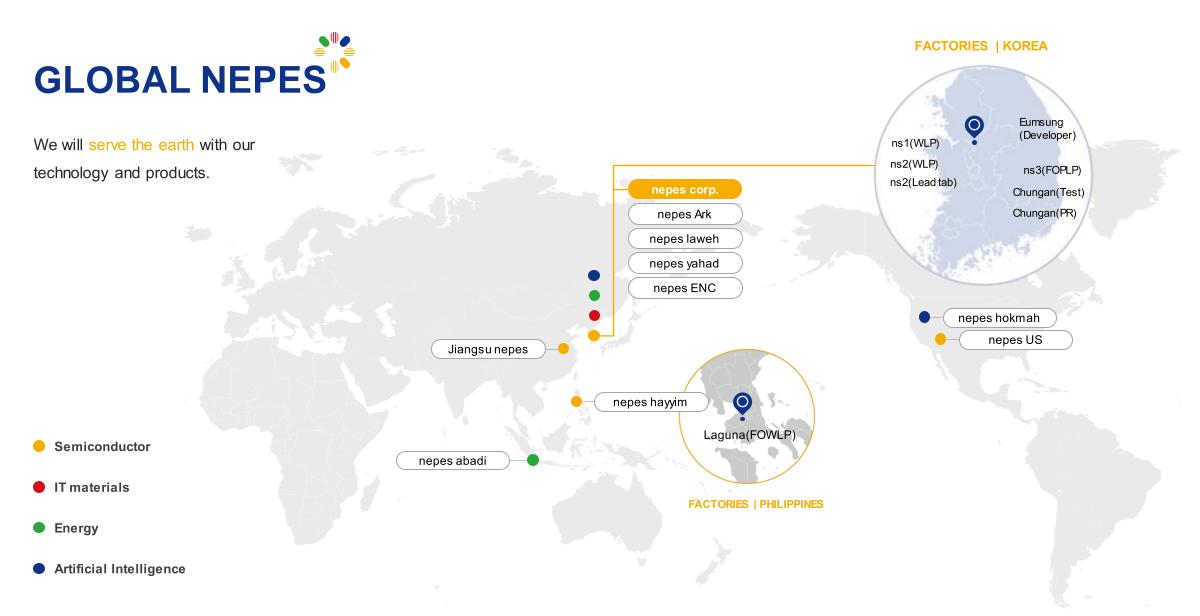
Signage & Electronics





RECOGNITION

APPENDIX



Part.03

# RECOGNITIONS

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Korea Semiconductor	21
Corporate Culture best practice	22

## ne¦ses

## White House report quotation

RECOGNITION

It contained the proposal of strengthening the domestic semiconductor manufacturing ecosystem by highlighting advance packaging necessary for important national security other than commercial use, and this shed light on Nepes among the global top 10 companies

BUILDING RESILIENT SUPPLY CHAINS, REVITALIZING AMERICAN MANUFACTURING, AND FOSTERING BROAD-BASED GROWTH

100-Day Reviews under Executive Order 14017

June 2021

A Report by The White House

Including Review: by Department of Commerce Department of Energy Department of Defense Department of Health and Human Services





• It contained the proposal of strengthening the domestic semiconductor manufacturing ecosystem by highlighting advance packaging necessary for important national security other than commercial use, and this shed light on nepes among the global top 10 companies

#### Advanced Packaging: Current Resilience

[43p.]

The top 10 advanced packaging companies include: two IDMs (Intel (U.S.) and Samsung (South Korea)); a foundry (TSMC (Taiwan)); the top five global OSATs (ASE Group (Taiwan), SPIL (Taiwan), Amkor (U.S.), Powertech Technology (Taiwan), and JCET (China)) and two smaller OSAT : Nepes (South Korea) and Chipbond (Taiwan)). These 10 companies process approximately three-fourths of all advanced packaged chips.<sup>92</sup>

[Source: The White House, 'Building Resilient Supply Chains, Revitalizing American Manuf acturing, and Fostering Broad-based Growth', Jun '21]

RECOGNITION

## Joining ASIC : American Semiconductor Innovation coalition

IBM and other coalition members feel that Nepes can bring a tremendous value to the coalition with its expertise in the advanced packaging such as wafer level processing and fan-out technologies



The News with Shepard Smith ? @thenewsoncnbc · Apr 23 ···· Congress will be back in session from a recess next week. A top item on the agenda is a bill that would dedicate \$52B to making more semiconductors in America. U.S. scientists invented the tiny computer chips, but most of them are now made in Asia. @ylanmui reports from New York.



## Coalition Members Include











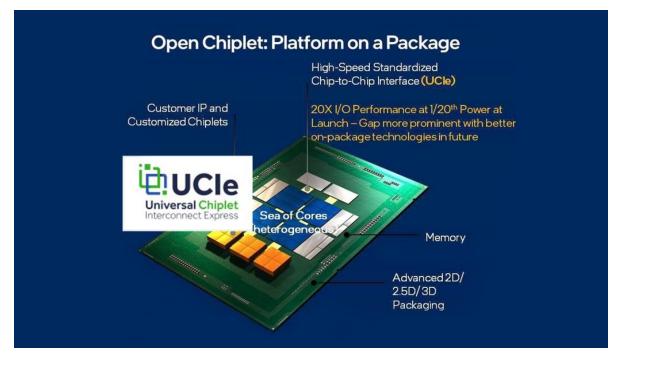




## Joining UCle : Universal Chiplet Interconnect Express

RECOGNITION

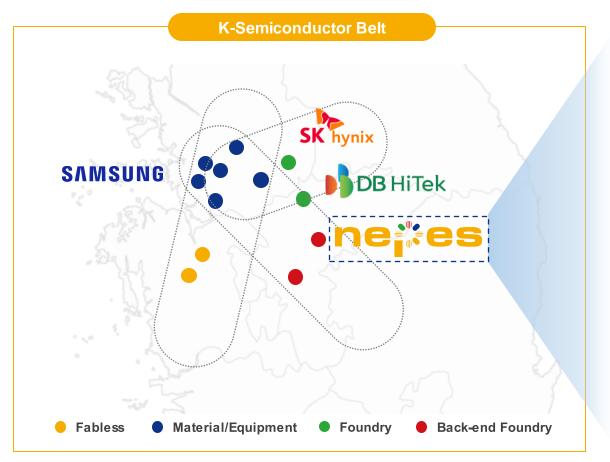
Major global semiconductors (Samsung, Intel, AMD, Arm, etc.) and IT companies (Microsoft, Meta, etc.) participate to establish a new standard for advanced package technology structure, which is evaluated as an alternative to overcome technological limitations due to ultra-fine process conversion

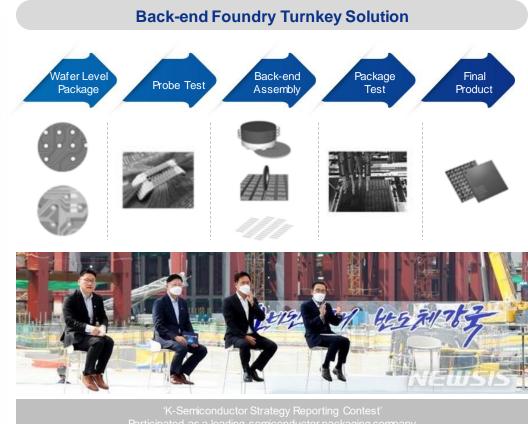




RECOGNITION

# Core back-end foundry for k-semiconductor belt





## **Korea Semiconductor**

A company with global growth potential in the field of core strategic technology

2022.01.10



RECOGNITION

**WINNER 2022** 2022.09.02

A company selected as the best brand of the year through a public consumer vote



LIGHTHOUSE **ENTERPRISE** 2022.11.17

An exemplary medium-sized enterprise that provides a direction for other companies



KOREA WORLD CLASS 2022.11.18

Products that contribute to national economic development with high technology and competitiveness

Karne Trade Investor

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ABOUTNEPES

# CORPORATE CULTURE & Chairman of Nepe Byung-Koo Lee **BEST PRACTICES**

Nepes' unique management philosophy has been recognized as a creative competitiveness that drives continuous growth of the organization and has been introduced as an excellent management case at various international academic conferences.

## St. John's Univ. (2022.5.19-21)

FIFTH GLOBAL CONFERENCE ON INTERNATIONAL HUMAN RESOURCE MANAGEMENT







the Silver Tower Order of Industrial Service Merit in Venture

as the Director of the Production Technology Center, LG

1) Global Conference on International HR Management 2) Global Conference on Positive Organization 3) CEO book (Amazon, Naver, Interpark bestseller)

글로벌 전문기업 경영자가 알려주

성과 창출의 비결 직원들이 노래 부르고, 책을 읽 감사 편지를 쓰게 하라 것이 바로 지속 성장의 비

로벌 히든 챔피언으로 이끄는 **지속 성장의 힘** 

그래티튜드경영

## ne¦es

# THANK YOU

To Him who alone does great wonders, His love endures forever. Psalm 136:4 \* A dandelion means 'Gratitude' in the language of flowers



2415, Nambusunhwan-ro, Seocho-gu, Seoul, Korea Tel : 02-3470-2700 Fax : 02-3470-2708 www.nepes.co.kr

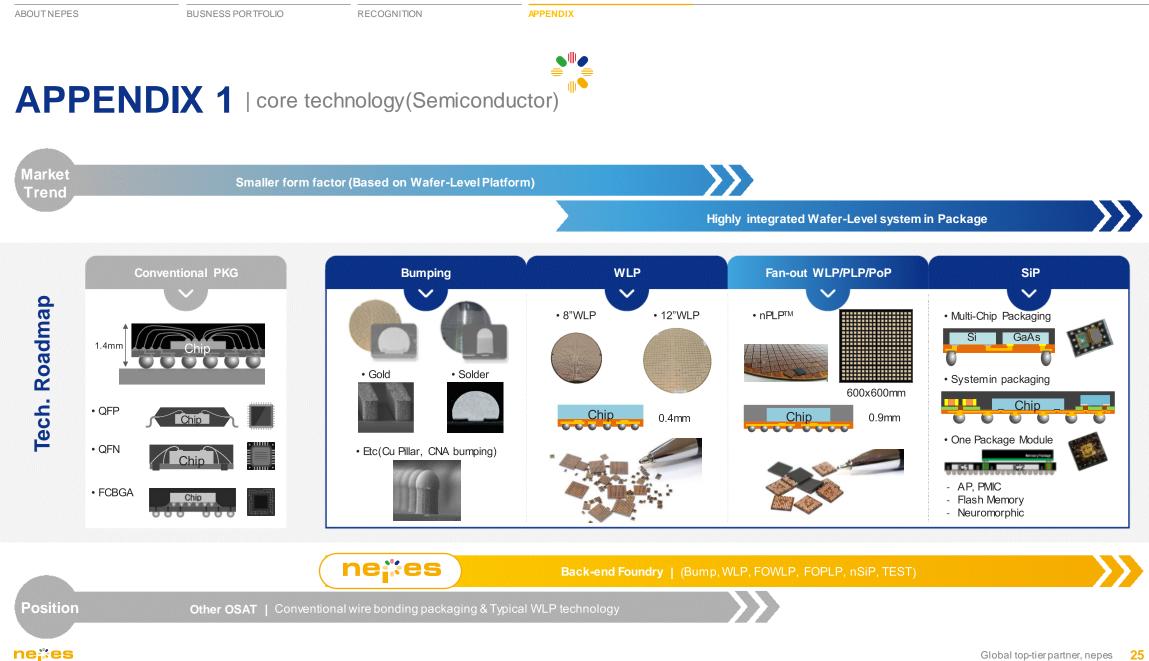
## Part.04

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- What is FOPLP? 28

# ne¦:es

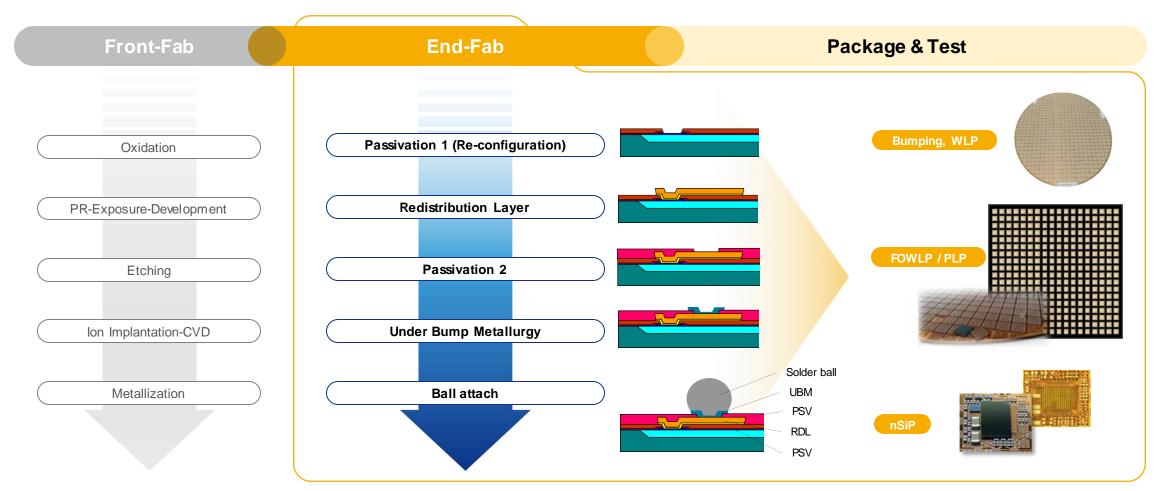


Global top-tier partner, nepes 25

# **APPENDIX 2** | What is End-fab?

End-fab refers to Passivation, RDL, and Bump processes after Front-Fab

RECOGNITION



# **APPENDIX 3** | What is FOPLP?

- Nepes sets new standards for FOPLP with the world's largest panel size
- Nepes has created a unique FOPLP technology based on FOWLP, internal materials (chemicals) development, and End-fab

